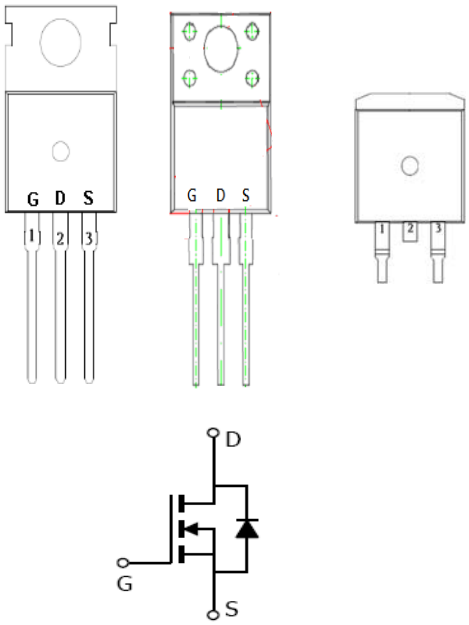
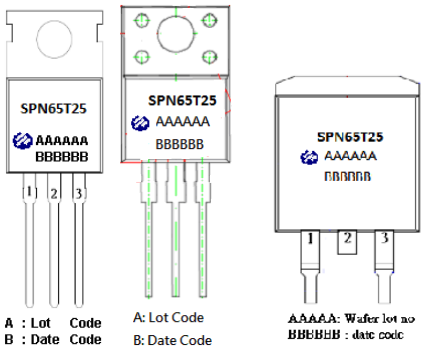
SPN65T25
N-Channel Enhancement Mode MOSFET

DESCRIPTION
The SPN65T25 is the N-Channel enhancement mode power field effect transistor which is produced using super high cell density DMOS trench technology. This high density process is especially tailored to minimize on-state resistance. These devices are particularly suitable for synchronous rectifier application, Motor control power management and other Power Tool circuits. It has been optimized for low gate charge, low $R_{DS(ON)}$ and fast switching speed.

APPLICATIONS
- AC/DC Synchronous Rectifier
- Load Switch
- UPS
- Power Tool
- Motor Control

FEATURES
- 250V/90A, $R_{DS(ON)}$=22mΩ@V_{GS}=10V
- High density cell design for extremely low $R_{DS(ON)}$
- Exceptional on-resistance and maximum DC current capability
- TO-220-3L/TO-220F-3L/TO-263-2L package design

PIN CONFIGURATION


PART MARKING


SPN65T25
N-Channel Enhancement Mode MOSFET

PIN DESCRIPTION

Pin	Symbol	Description
1	G	Gate
2	D	Drain
3	S	Source

ORDERING INFORMATION

Part Number	Package	Part Marking
SPN65T25T220TGB	TO-220-3L	SPN65T25
SPN65T25T220FTGB	TO-220F-3L	SPN65T25
SPN65T25T262RGB	TO-263-2L	SPN65T25

※ SPN65T25T220TGB : Tube ; Pb – Free ; Halogen – Free
※ SPN65T25T220FTGB : Tube ; Pb – Free ; Halogen – Free
※ SPN65T25T262RGB : Tape Reel ; Pb – Free ; Halogen – Free

ABSOULTE MAXIMUM RATINGS

(T_A=25℃ Unless otherwise noted)

Parameter		Symbol	Typical	Unit
Drain-Source Voltage		V_{DSS}	250	V
Gate –Source Voltage		V_{GSS}	±20	V
Continuous Drain Current (Silicon Limited)	T_C=25℃	I_D	90	A
	T_C=100℃		64	
Pulsed Drain Current		I_{DM}	281	A
Avalanche Energy, Single Pulse @ L=0.4mH, T_C=25℃		E_{AS}	180	mJ
Power Dissipation @ T_C=25℃		P_D	358	W
Operating Junction Temperature		T_J	-55/150	℃
Storage Temperature Range		T_{STG}	-55/150	℃
Thermal Resistance-Junction to Case		$R_{\theta JC}$	0.35	℃/W

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N-Channel Enhancement Mode MOSFET

ELECTRICAL CHARACTERISTICS

(T_A=25℃ Unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
Static						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	V_{GS}=0V,I_D=250uA	250			V
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS}=V_{GS},I_D=250uA	2.0	3.0	4.0	
Gate Leakage Current	I_{GSS}	V_{DS}=0V,V_{GS}=±20V			±100	nA
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS}=200V,V_{GS}=0V T_J=25℃			1	uA
		V_{DS}=200V,V_{GS}=0V T_J=100℃			100	
Drain-Source On-Resistance	$R_{DS(on)}$	V_{GS}=10V,I_D=20A		16.5	22	mΩ
Forward Transconductance	gfs	V_{DS}=5V,I_D=20A		70		S
Gate Resistance	R_G	V_{GS}=0V,V_{DS}=Open, f=1MHz		3.7		Ω
Diode Forward Voltage	V_{SD}	I_F=20A,V_{GS}=0V		0.9	1.2	V
Dynamic						
Total Gate Charge	Q_g	V_{DS}=125V, V_{GS}=10V I_D=20A		58		nC
Gate-Source Charge	Q_{gs}			18		
Gate-Drain Charge	Q_{gd}			6		
Input Capacitance	C_{iss}	V_{DS}=100V,V_{GS}=0V f=1MHz		4970		pF
Output Capacitance	C_{oss}			350		
Reverse Transfer Capacitance	C_{rss}			7.5		
Turn-On Time	$t_{d(on)}$	V_{DD}=125V, V_{GS}=10V I_D=20A, R_G=10Ω		16		nS
	t_r			22		
Turn-Off Time	$t_{d(off)}$			38		
	t_f			10		
Reverse Recovery Time	trr	V_R=125V, I_F=20A, dIF/dt=100A/uS		165		nS
Reverse Recovery Charge	Qrr			830		nC

TYPICAL CHARACTERISTICS

Fig 1. Typical Output Characteristics

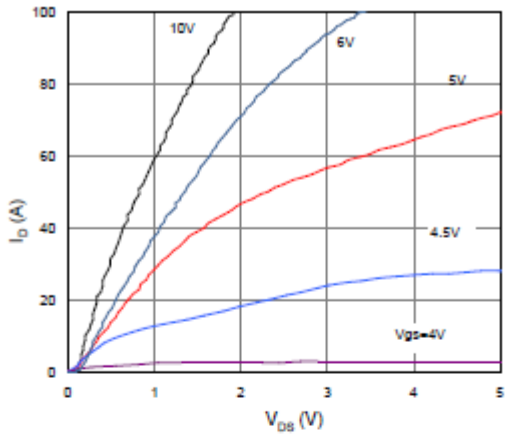


Figure 2. On-Resistance vs. Gate-Source Voltage

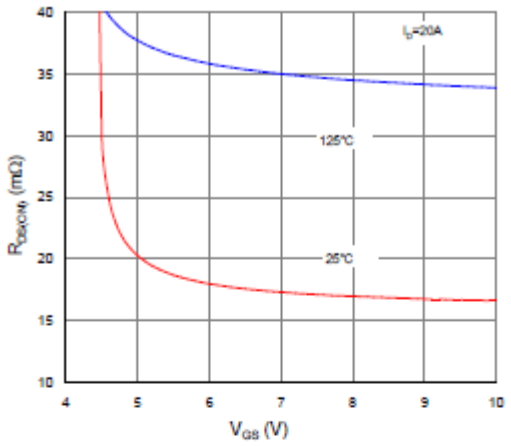


Figure 3. On-Resistance vs. Drain Current and Gate Voltage

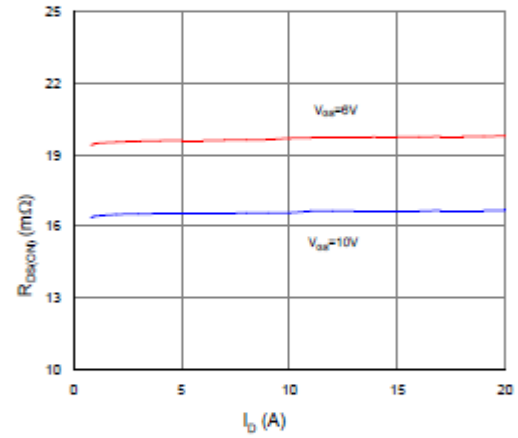


Figure 4. Normalized On-Resistance vs. Junction Temperature

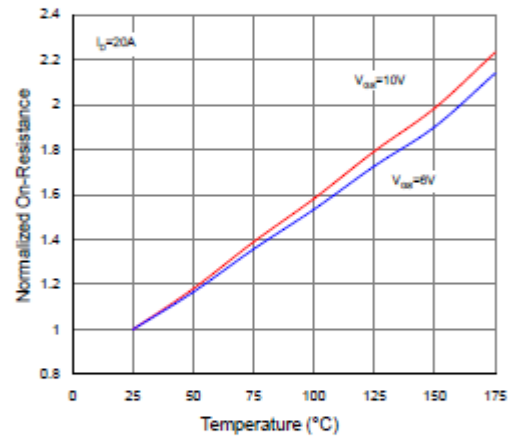


Figure 5. Typical Transfer Characteristics

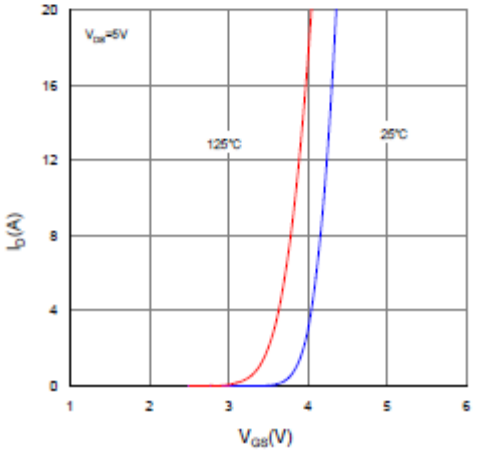
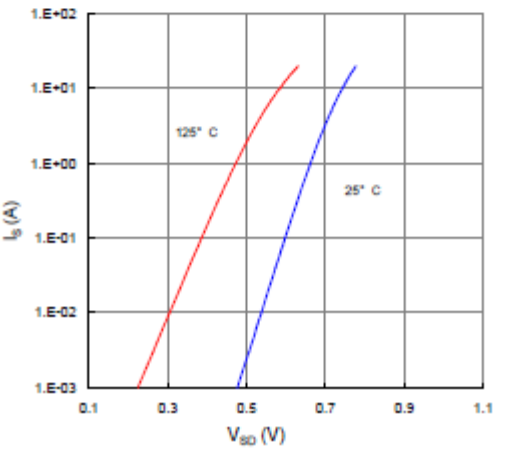


Figure 6. Typical Source-Drain Diode Forward Voltage



TYPICAL CHARACTERISTICS

Figure 7. Typical Gate-Charge vs. Gate-to-Source Voltage

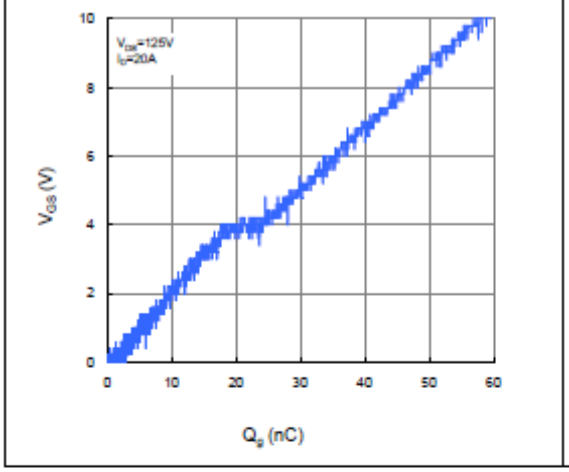


Figure 8. Typical Capacitance vs. Drain-to-Source Voltage

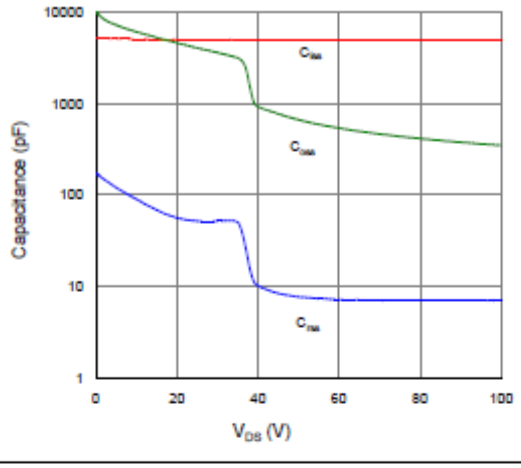


Figure 9. Maximum Safe Operating Area

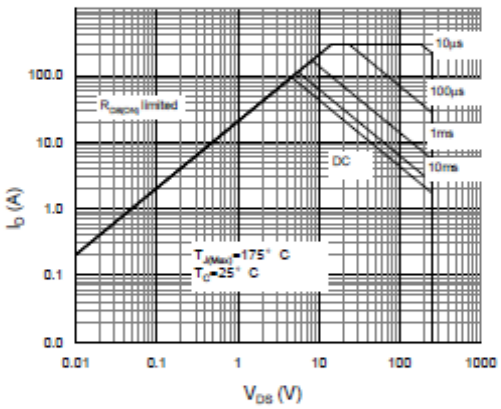


Figure 10. Maximun Drain Current vs. Case Temperature

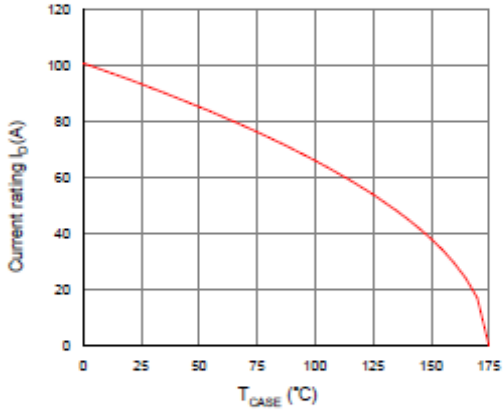
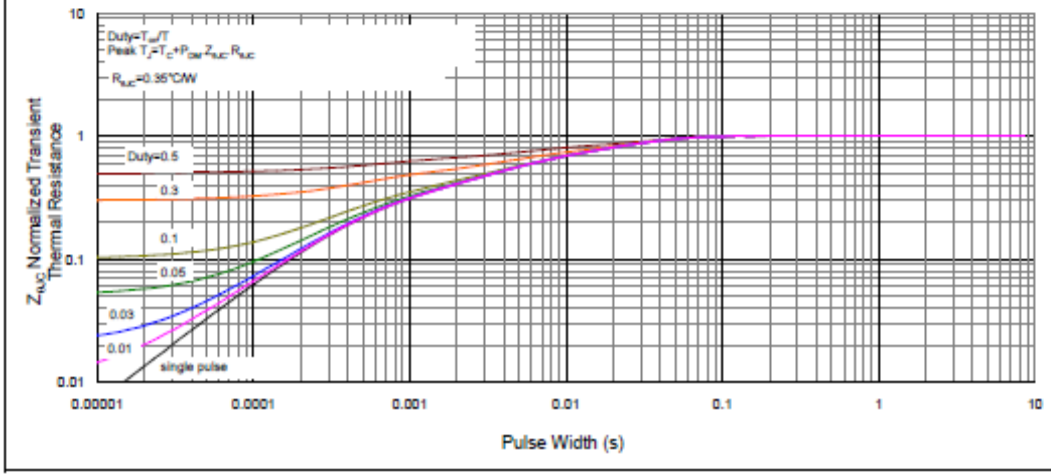
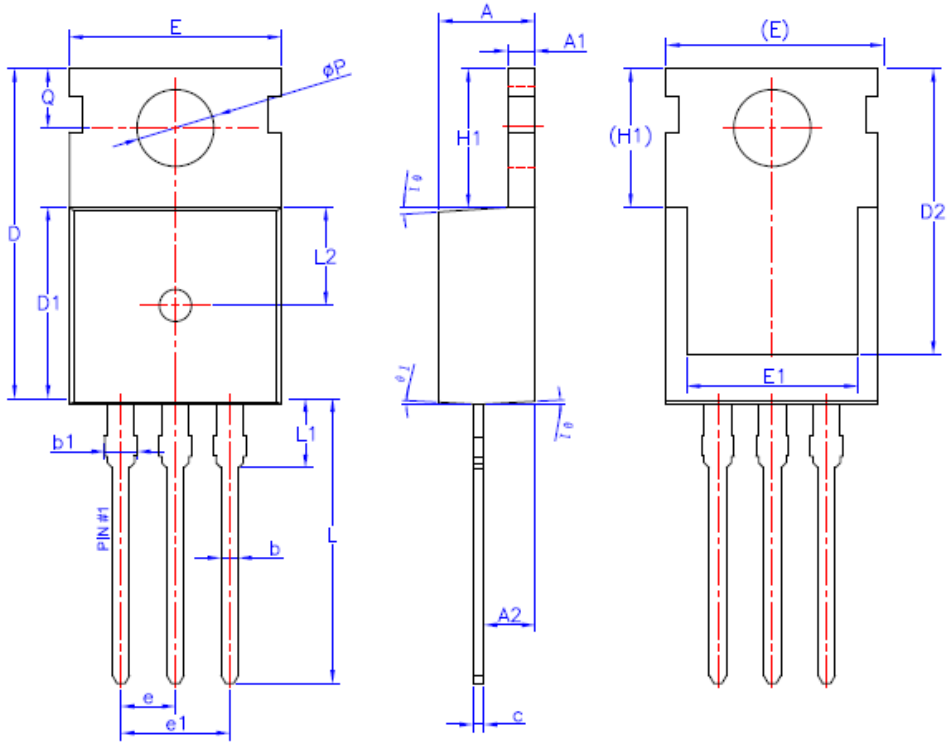


Figure 11. Normalized Maximum Transient Thermal Impedance, Junction-to-Case

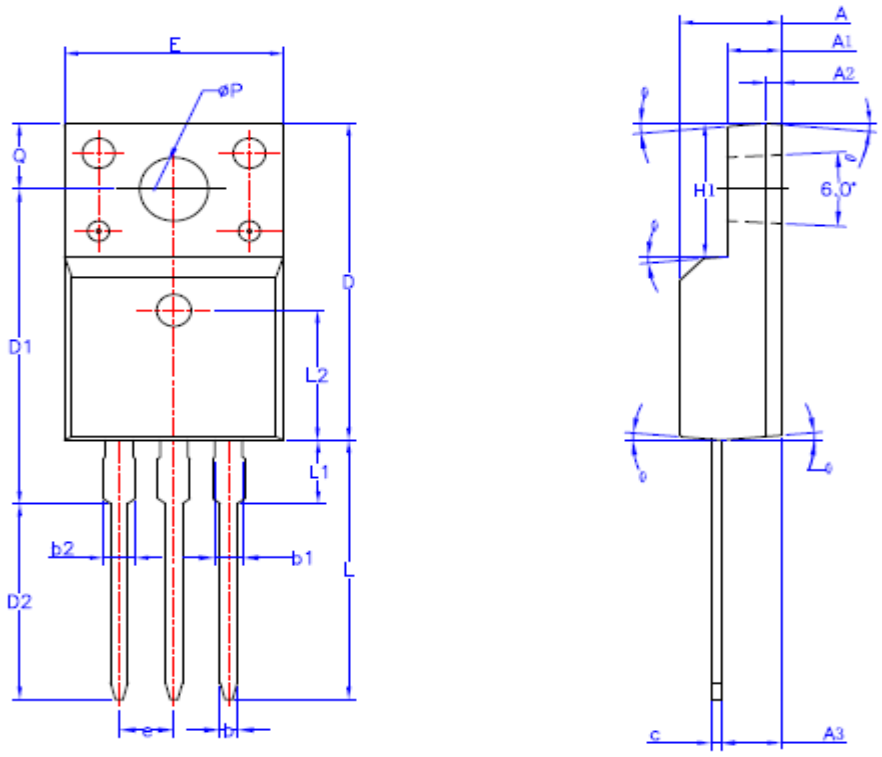


TO-220-3L PACKAGE OUTLINE



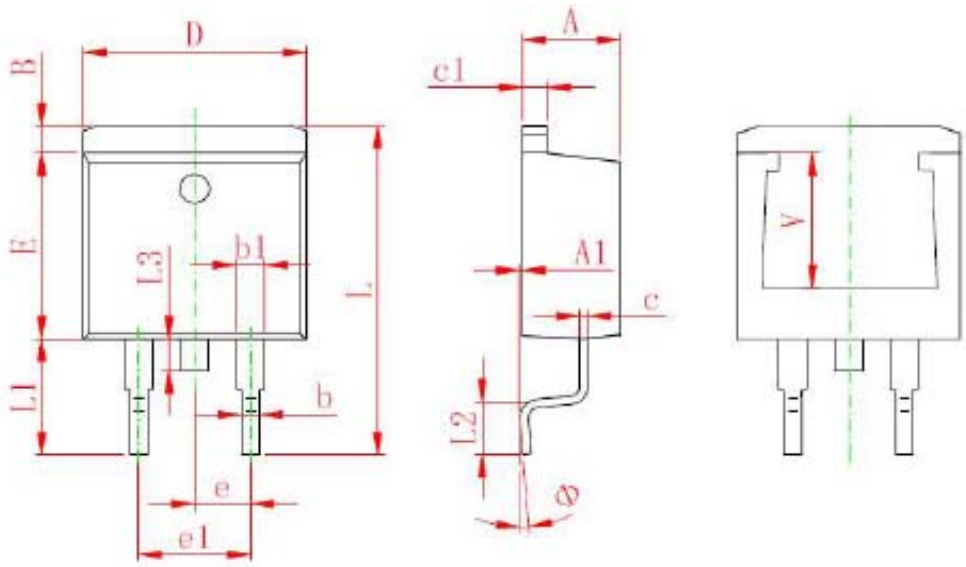
SYMBOL	MIN	NOM	MAX
A	4.40	4.50	4.60
A1	1.27	1.30	1.33
A2	2.30	2.40	2.50
b	0.70	0.60	0.90
b1	-	-	1.40
c	0.45	0.50	0.60
D	15.30	15.70	16.10
D1	9.10	9.20	9.30
D2	13.10	-	13.70
E	9.70	9.90	10.20
E1	7.80	8.00	8.20
e	2.54BSC		
e1	5.08BSC		
H1	6.30	6.50	6.70
L	12.78	13.08	13.38
L1	-	-	3.50
L2	4.6REF		
φP	3.55	3.60	3.65
Q	2.73	-	2.87
θ1	1°	3°	5°

TO-220F-3L PACKAGE OUTLINE



SYMBOL	MIN	NOM	MAX
A	4.50	4.70	4.83
A1	2.34	2.54	2.74
A2		0.7REF	
A3	2.56	2.76	2.93
b	0.70	--	0.90
b1	1.18	--	1.40
b2	--	--	1.47
c	0.45	0.50	0.60
D	15.67	15.87	16.07
D1	15.55	15.75	15.95
D2	9.60	9.80	10.00
E	9.96	10.16	10.36
e		2.54BSC	
H1	6.48	6.68	6.88
L	12.68	12.98	13.28
L1	-	-	3.50
L2		6.50REF	
φP	3.08	3.18	3.28
Q	3.20	-	3.40
θ1	1°	3°	5°

TO-263-2L PACKAGE OUTLINE



Unit : mm

SYMBOL	MIN	NOM	MAX
A	4.30	4.50	4.70
A1	0.00	0.10	0.25
B	1.12	-	1.42
b	0.70	-	0.91
b1	1.17	--	1.37
c	0.31	--	0.55
c1	1.17	--	1.37
D	10.01	--	10.31
E	8.50	8.70	8.90
e	2.54TYP.		
e1	4.93	--	5.23
L	14.90	--	15.50
L1	4.95	5.20	5.45
L2	2.34	2.54	2.74
L3	1.30	1.50	1.70
Ø	0°	--	8°
V	5.400REF		

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